



N-Channel $\mathbf{Q}_{\mathbf{g}}$, Fast Switching WFET®

PRODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	I _D (A)		
30	0.0095 at V _{GS} = 10 V	12.5		
	0.0135 at V _{GS} = 4.5 V	10.5		

Halogen-free According to IEC 61249-2-21 Available The second of the seco

FEATURES

Extremely Low Q_{gd} WFET Technology for Switching Losses

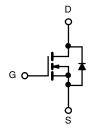


• 100 % R_g Tested

ROHS COMPLIANT HALOGEN FREE Available

APPLICATIONS

- High-Side DC/DC Conversion
 - Notebook
 - Server



N-Channel MOSFET

		SO-8		
s	1		8	D
S	2		7	D
S	3		6	D
G	4		5	D
	l	Top View	I	

Ordering Information: Si4390DY-T1-E3 (Lead (Pb)-free)

Si4390DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS	$T_A = 25 ^{\circ}C$, unle	ss otherwise n	noted		
Parameter		Symbol	10 s	Steady State	Unit
Drain-Source Voltage		V _{DS}	30		V
Gate-Source Voltage		V_{GS}	± 20		
Continuous Dunin Courset /T. 150 °CV8	T _A = 25 °C	- I _D	12.5	8.5	
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 70 °C		10	6.8	Α
Pulsed Drain Current		I _{DM}	20		A
Continuous Source Current (Diode Conduction) ^a		I _S	2.7	1.3	
Maximum Power Dissipation ^a	T _A = 25 °C	P _D	3.0	1.4	W
	T _A = 70 °C		1.9	0.9	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Marrian una lumation ta Analianta	t ≤ 10 s	R _{thJA}	32	42	°C/W
Maximum Junction-to-Ambient ^a	Steady State		68	90	
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	15	20	

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

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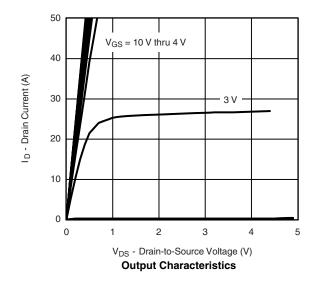
Parameter	Symbol	Test Conditions	Тур.	Max.	Unit	
Static			•		<u>'</u>	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	0.8		2.8	V
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V			1	
		V_{DS} = 30 V, V_{GS} = 0 V, T_J = 55 °C			5	μΑ
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	30			Α
Drain-Source On-State Resistance ^a	Ь	V _{GS} = 10 V, I _D = 12.5 A		0.0075	0.0095	0
	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 10.5 \text{ A}$		0.0105	0.0135	Ω
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 12.5 A		38		S
Diode Forward Voltage ^a	V_{SD}	$I_S = 2.7 \text{ A}, V_{GS} = 0 \text{ V}$		0.7	1.1	V
Dynamic ^b	•		•			
Total Gate Charge	Q_g			10	15	
Gate-Source Charge	Q _{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 12.5 \text{ A}$		3.5		nC
Gate-Drain Charge	Q_{gd}			2.1		
Gate Resistance	R_g		0.2	0.8	1.4	Ω
Turn-On Delay Time	t _{d(on)}			16	30	
Rise Time	t _r	V_{DD} = 15 V, R_L = 15 Ω		6	12	
Turn-Off Delay Time	t _{d(off)}	$I_D\cong$ 1 A, V_{GEN} = 10 V, R_g = 6 Ω		43	70	ns
Fall Time	t _f			14	25	
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 2.7 A, dl/dt = 100 A/μs		35	60	

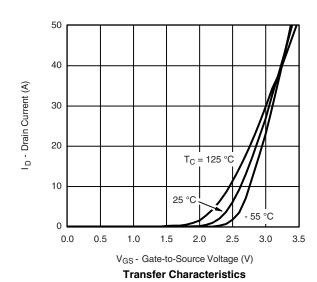
Notes:

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



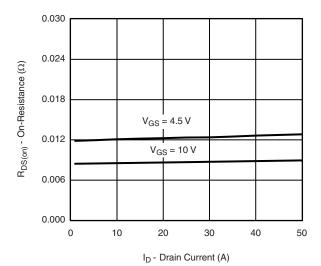




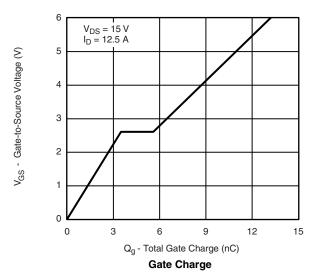


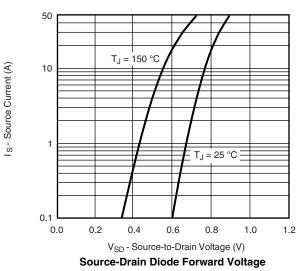


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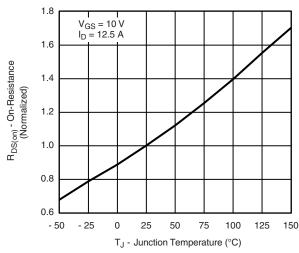
On-Resistance vs. Drain Current



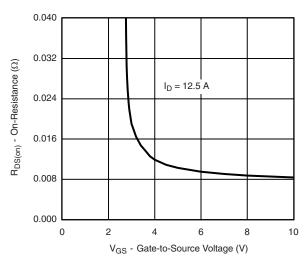


1800 $\mathsf{C}_{\mathsf{iss}}$ 1500 C - Capacitance (pF) 1200 900 C_{oss} 600 300 C_{rss} 0 0 6 12 18 24 30

V_{DS} - Drain-to-Source Voltage (V) **Capacitance**



On-Resistance vs. Junction Temperature

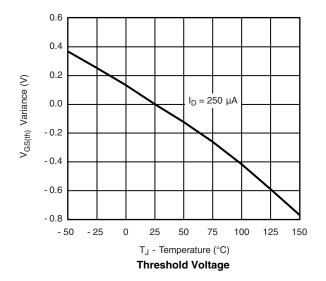


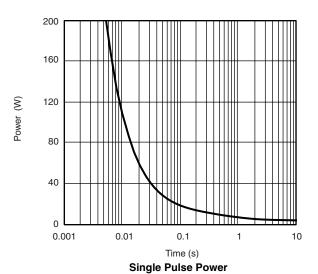
On-Resistance vs. Gate-to-Source Voltage

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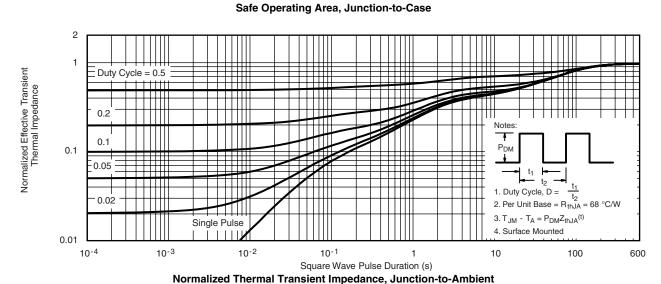
VISHAY

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



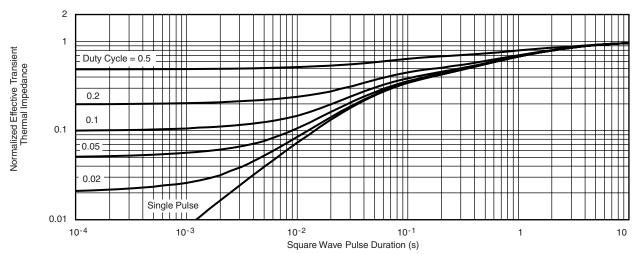


100 Limited b 1 ms 10 I_D - Drain Current (A) 100 ms 0.1 10 s T_C = 25 °C Single Pulse DC 0.01 0.1 10 100 V_{DS} - Drain-to-Source Voltage (V) * V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified





TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot

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